R	0	Н	M
SEN	IICO	NDU	CTOR

TYPE

STRUCTURE	:	SILICON	MONOLITHIC	INTEGRATED	CIRCUIT

FUNCTION : EARTH LEAKAGE CURRENT DETECTOR

PRODUCT FEATURES

- : BD9582F/N(SOP/SIP)
 - SOP8/SIP8 Package
 Good temperature characteristics of input sensitivity current
 - •Wide operating temperature range(Ta= $-20 \sim 95^{\circ}$ C)

OABSOLUTE MAXIMUM RATINGS(Ta=25[°C])

Parameter	Symbol	Rating	Unit	Condition
Supply current (*3)	l _s	8	mA	
VR-IN current	I _{VR-IN}	±250	mA	Between IN-VR
VR pin current	l _{vr}	30	mA	Between VR-GND
IN terminal current	l _{IN}	30	mA	Between IN-GND
SC terminal current	l _{sc}	5	mA	
SC/OD/NR/OS terminal voltage	V _{od/sc/nr/os}	8	v	
Power dissipation	P _d	0. 68 (S0P8 *1) 1. 12 (SIP8 *2)	W	
Storage temperature	T _{stg}	-55~150	°C	

•This IC is not designed for protection against radioactive rays.

(*1) To use at temperature above $Ta=25[^{\circ}C]$ reduce 5.5[mW]/[$^{\circ}C$]. Mounted on a glass epoxy PCB (70[mm] × 70[mm] × 1.6[mm]) (*2) To use at temperature above $Ta=25[^{\circ}C]$ reduce 9.0[mW]/[$^{\circ}C$]. Pd is a value in the package unit.

(*2) To use at temperature above Ta 25[C] reduce 9.0[mw]/[C]. Pd is a value (*3) The power-supply voltage is limited by the internal clamping circuit.

ORECOMMENDED OPERATING CONDITIONS

_			
	Parameter	Symbol	Limit
		Joyinbur	Min T.m

Parameter	Symbol		Unit		
Farameter	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	٧s	12	_	22	۷
Operating temperature	T _{opr}		-20~95		°C
External capacitor between Vs and GND	C _{vs}	1	-	-	μF
External capacitor between Os and GND	C _{os}	-	-	1	μF

Status of this document

The Japanese version of this document is the formal specification.

A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority.

Application example

 $\textbf{\cdot ROHM} \text{ cannot provide adequate confirmation of patents}.$

- •The product described in this specification is designed to be used with ordinary electronic equipment or devices (such as audio-visual equipment, office-automation equipment, communications devices, electrical appliances, and electronic toys).
- Should you intend to use this product with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical Instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.
- -ROHM assumes no responsibility for use of any circuits described herein, conveys no license under any patent or other right, and makes no representations that the circuits are free from patent infringement.
- ·If change is made to the constant of an external circuit, allow a sufficient margin due to variations of the characteristics of the products and external components, including transient characteristics, as well as static characteristics.
- •The application examples, their constants, and other types of information contained herein are applicable only when the products are used in accordance with standard methods. Therefore, if mass production is intended, sufficient consideration to external conditions must be made.



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BD9582F/N

TYPE

Demonstern			Ŧ		Limit			Test circuit
Parameter	Symbol	Condition	Temp	Min.	Тур.	Max.		
			-20	_	-	520		
Supply current	I _{S1}	VR-VI=30mV	25	-	330	500	μA	1
			95	_	-	460		
Trip voltage	VT	VT=VR-VI	-20 ~ +95	4. 92 (3. 48)	7.50 (5.30)	11.06 (7.82)	mV (mVrms)	2
OD source current	I _{ODSO}	VR-VI=30mV, Vod=1.2V	25	-27. 2	-20. 6	-14. 0	μA	3
OD sink current	I _{ODS I}	Vod=0. 8V, Vr-Vi=0mV	25	16. 7	26. 0	35. 3	μA	4
			-20	-200	_	-	1	
OS source current I _{OSSO}	Vsc=2. 0V Vos=0. 8V	25	-100	_	_	μA	5	
			95	-75	_	_		
OS sink current	I _{ossi}	Vsc=0. 2V, Vos=0. 2V	-20 ~ +95	200	_	_	μA	5
Sc ON voltage	V _{SCON}		25	1.00	1. 24	1. 48	v	6
Input clamp voltage	VIC	lıc=20mA	-20 ~ +95	4. 3	5.5	6. 7	v	7
Differential input clamp voltage	V _{IDC}	l idc=100mA	-20 ~ +95	0. 6	1.0	1.4	v	8
Maximum current voltage	V _{SM}	l sm=7mA	25	26	29	32	v	9
Supply current2 (*1)	I _{0S2}	Vr-V1=30mV, Vsc=2V Is=900uA	-20~ +95	-100	_	_	μA	10
atch circuit is off- state supply voltage	V _{SOFF}		25	2. 7	3. 7	4. 7	v	11
Operating time (*2)	t _{on}	VR-V1=0. 3V	25	1.8	2. 9	4.0	ms	12

(*1)Supply current2 means the output current value that can be secured when the decided power supply current(ls=900 μ A) is given.

(*2)Operating time means the time applying fixed input to reaching to 0.8V by the output voltage in 0.047 μ F between 0_D(0_S) and GND.

OBLOCK DIAGRAM



OPIN DESCRIPTION

No.	Symbol	Function
1	V _R	+ Input terminal
2	IN	— Input terminal
3	GND	Substrate ground
4	0 _D	Differential amplifier Output terminal
5	Sc	Input terminal of latch circuit
6	N _R	Terminal for noise absorption
7	0 _s	Output terminal
8	٧s	Power supply terminal

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SPECIFICATION No. TSZ02201-BD9582F/N-1-2





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SPECIFICATION No. TSZ02201-BD9582F/N-1-2



TYPE

OAPPLICATION EXAMPLE

